



SLD7N70S / SLU7N70S 700V N-Channel MOSFET

General Description

This Power MOSFET is produced using Msemitek's advanced planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

Features

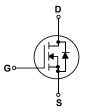
- N-Channel:700V 7A

 $R_{DS(on)Typ}$ = 1.3 Ω @ V_{GS} = 10 V

- Very Low On-resistance R_{DS(ON)}
- Low Crss
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability







Absolute Maximum Ratings

T_C = 25°C unless otherwise noted

Symbol	Parameter	SLD7N70S / SLU7N70S	Units
V _{DSS}	Drain-Source Voltage	700	V
	Drain Current - Continuous (Tc = 25°C)	7	Α
l _D	- Continuous (T _C = 100°C)	4.2	Α
I _{DM}	Drain Current - Pulsed (Note 1)	28	Α
V_{GSS}	Gate-Source Voltage	±30	V
E _{AS}	Single Pulsed Avalanche Energy	121	mJ
P_D	Power Dissipation (T _C = 25°C)	40	W
Rejc	Thermal Resistance, Junction to Case	3.07	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	°C

^{*} Drain current limited by maximum junction temperature.

Units

Max

Package Marking

Part Number	Top Marking	Package	Packing Method	MOQ	QTY
SLD7N70S	SLD7N70S	TO-252	Tape	2500	25000
SLU7N70S	SLU7N70S	TO-251	Tube	3750	18750

Electrical Characteristics

Parameter

T_C = 25°C unless otherwise noted

Test Conditions

Min

Тур

Off Characteristics							
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 uA	700	-	-	٧	
Inno	Zero Gate Voltage Drain Current	V _{DS} =700 V, V _{GS} = 0 V		1	uA		
IDSS	Zelo Gale Voltage Dialii Curient	V _{DS} = 560V, T _C = 125°C	-	-	10	uA	
Igssf	Gate-Body Leakage Current, Forward	V _{GS} =30V, V _{DS} = 0 V	ı	-	100	nA	
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA	

On Characteristics

Symbol

$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \text{ uA}$	2	ı	4	>
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D =3.5 A	-	1.3	1.6	Ω

Dynamic Characteristics

Ciss	Input Capacitance		1	1130	1	pF
Coss	Output Capacitance	V _{DS} =25 V, V _{GS} = 0 V, f = 1.0 MHz	1	110	1	pF
C _{rss}	Reverse Transfer Capacitance			5	-	pF

Switching Characteristics

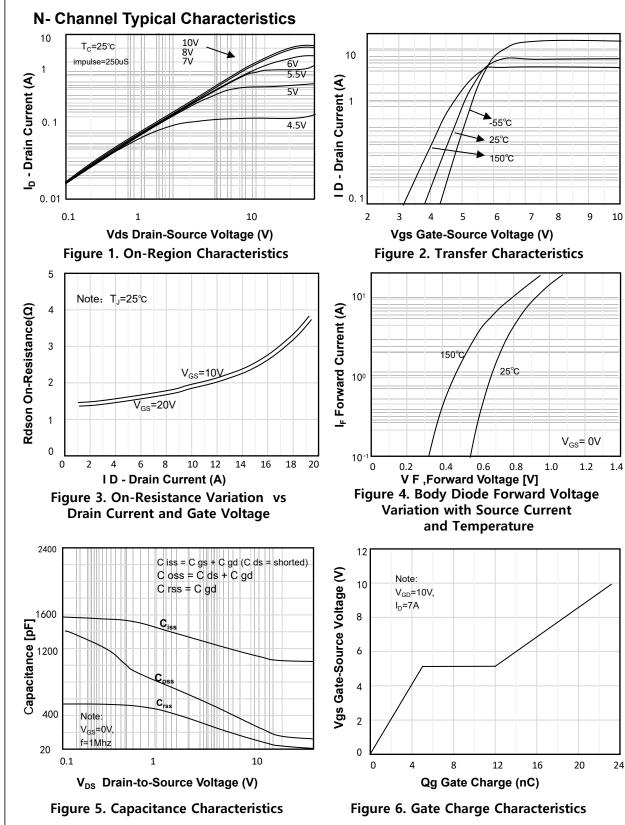
t _{d(on)}	Turn-On Delay Time			95.5		ns
tr	Turn-On Rise Time	V_{DS} = 350V, R _G = 25 Ω , I _D =7A	-	35.5	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	96	-	ns
t _f	Turn-Off Fall Time		-	35	-	ns
Q_g	Total Gate Charge	$V_{DS} = 560V, I_{D} = 7A,$	-	23.2	-	nC
Qgs	Gate-Source Charge	V _{GS} = 10V	-	8	-	nC
Q_{gd}	Gate-Drain Charge			5		nC

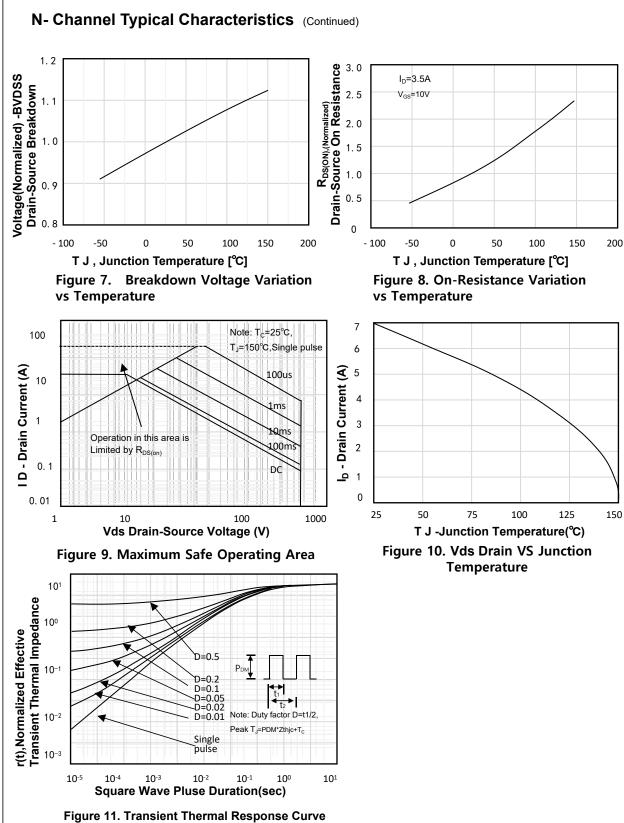
Drain-Source Diode Characteristics and Maximum Ratings

ls	Maximum Continuous Drain-Source Diode Forward Current	-	-	7	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current			28	Α
V _{SD}	Drain to Source Diode Forward Voltage, V GS = 0V, I SD = 7A, T J = 25°C	-	-	1.4	V
t _{rr}	Reverse Recovery Time &T _J = 25°C, IF = 20A di/dt = 100A/µs	-	650	-	nS
Qrr	Reverse Recovery Charge & T _J = 25°C, IF = 20A di/dt = 100A/µs		3.54	-	nC

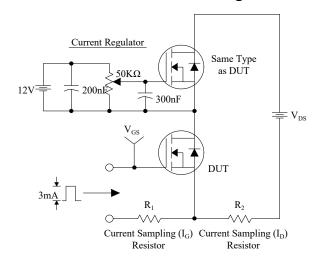
Notes:

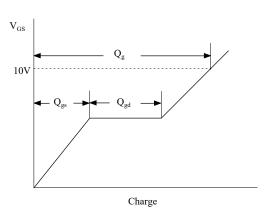
- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
- 2. EAS condition: T $_J$ =25°C, V $_{DD}$ =50V, V $_{G}$ =10V, R G =25 Ω , L=0.5mH, I $_{AS}$ =7A
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



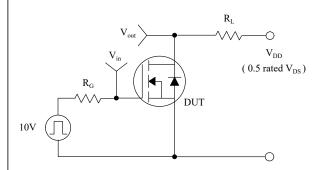


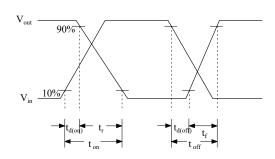
Gate Charge Test Circuit & Waveform



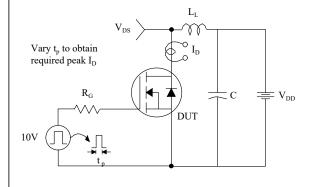


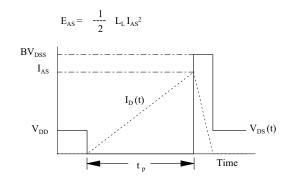
Resistive Switching Test Circuit & Waveforms



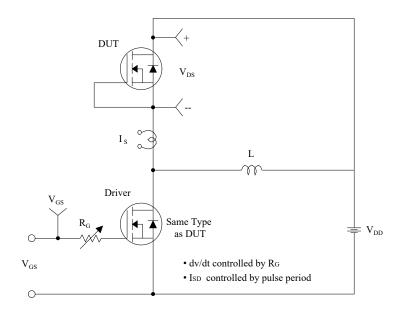


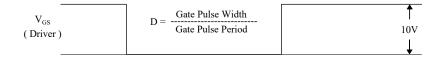
Unclamped Inductive Switching Test Circuit & Waveforms

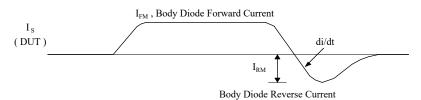


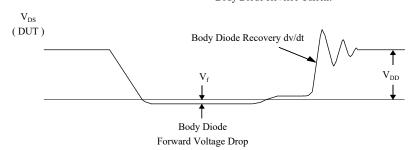


Peak Diode Recovery dv/dt Test Circuit & Waveforms

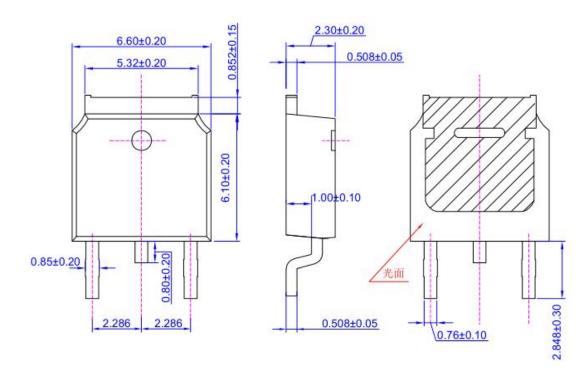


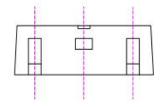






TO-252 OUTLINE

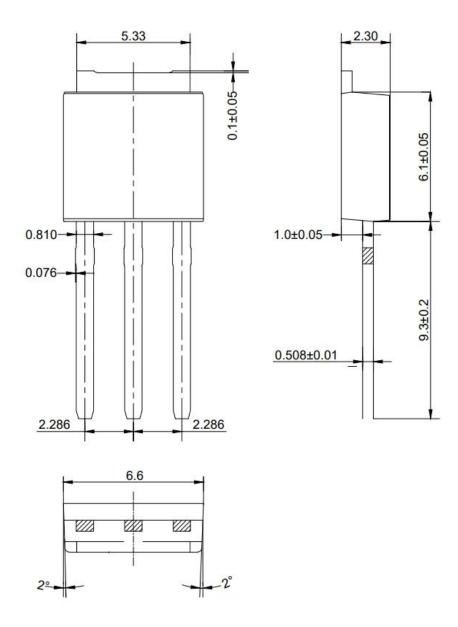




NOTE:

1The plastic package is not marked as smooth surfaceRa=0.1;Subglossy surfaceRa=0.8 2.Undeclared tolerance \pm 0.25,Unmarked filletRmax=0.25

TO-251 OUTLINE



Note:

1,Unit: millimeters

2,The tolerance not noted is \pm 0.15, and the unmarked fillet Rmax = 0.25

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